

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# RQK0607AQDQS

## Silicon N Channel MOS FET Power Switching

REJ03G1620-0100

Rev.1.00

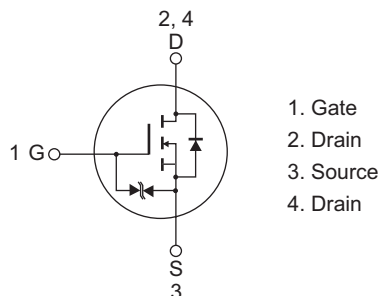
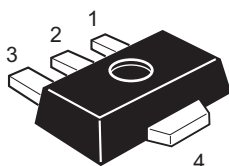
Mar 03, 2008

### Features

- Low on-resistance  
 $R_{DS(on)} = 210 \text{ m}\Omega$  typ.(at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 1.2 \text{ A}$ )
- Low drive current
- High speed switching
- $V_{DSS} : 60 \text{ V}$  and capable of 2.5 V gate drive

### Outline

RENESAS package code: PLZZ0004CA-A  
(Package name: UPAK®)



1. Gate
2. Drain
3. Source
4. Drain

Note: Marking is "AQ".

### Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	60	V
Gate to source voltage	$V_{GSS}$	$\pm 12$	V
Drain current	$I_D$	2.4	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	8	A
Body - drain diode reverse drain current	$I_{DR}$	2.4	A
Channel dissipation	$P_{ch}$ <sup>Note2</sup>	1.5	W
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

Notes: 1.  $PW \leq 10 \mu\text{s}$ , Duty cycle  $\leq 1\%$

2. When using the glass epoxy board (FR-4 40 × 40 × 1 mm)

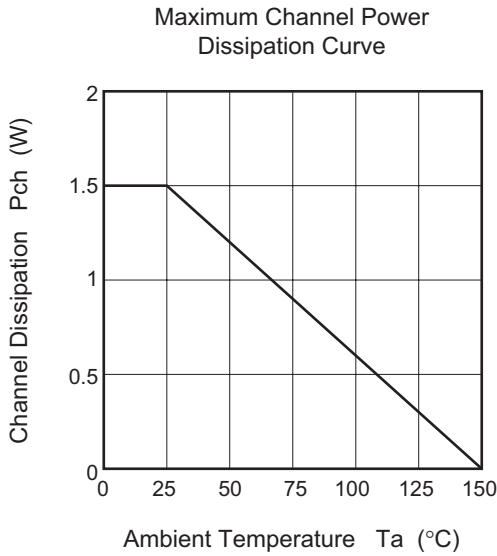
## Electrical Characteristics

(Ta = 25°C)

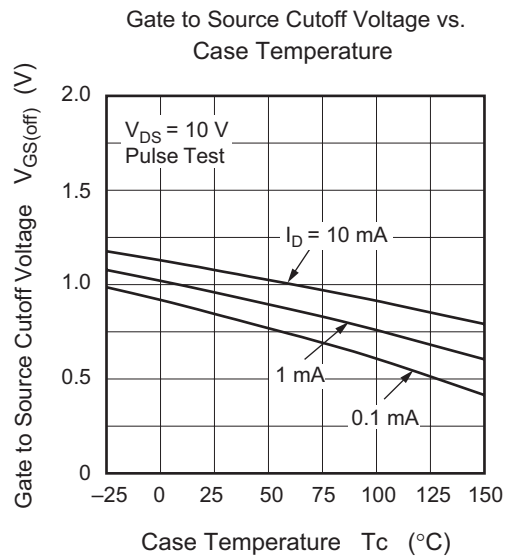
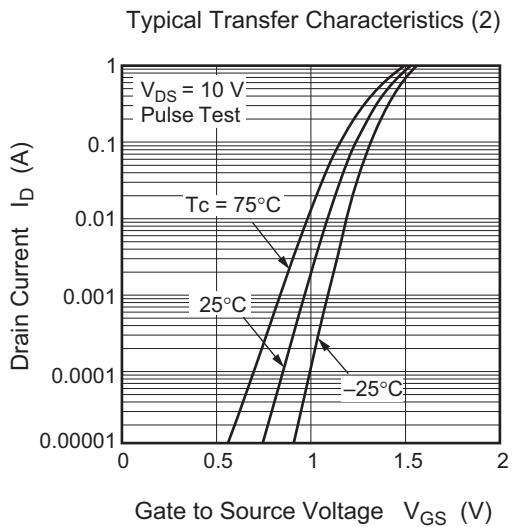
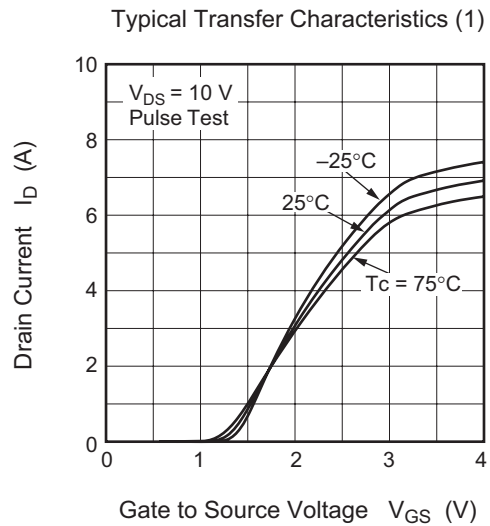
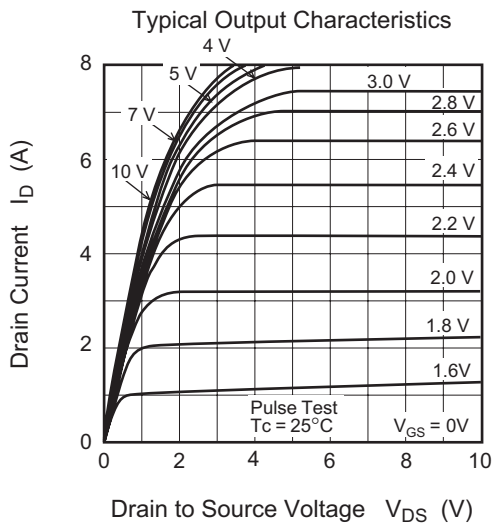
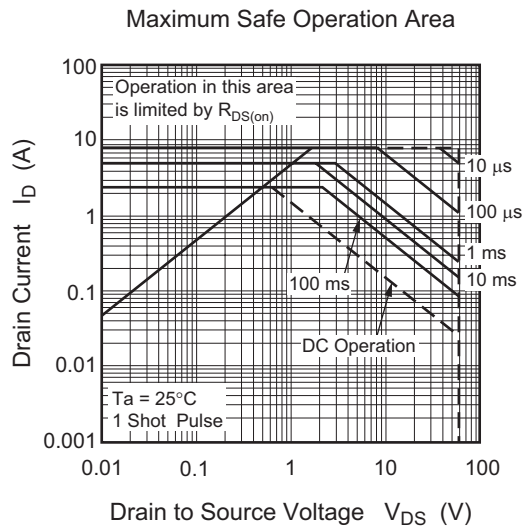
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	+12	—	—	V	$I_G = +100 \text{ } \mu\text{A}$ , $V_{DS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	-12	—	—	V	$I_G = -100 \text{ } \mu\text{A}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	+10	$\mu\text{A}$	$V_{GS} = +10 \text{ V}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	-10	$\mu\text{A}$	$V_{GS} = -10 \text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 60 \text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}$ , $I_D = 1 \text{ mA}$
Drain to source on state resistance	$R_{DS(on)}$	—	210	270	$\text{m}\Omega$	$I_D = 1.2 \text{ A}$ , $V_{GS} = 4.5 \text{ V}$ <sup>Note3</sup>
Drain to source on state resistance	$R_{DS(on)}$	—	250	350	$\text{m}\Omega$	$I_D = 1.2 \text{ A}$ , $V_{GS} = 2.5 \text{ V}$ <sup>Note3</sup>
Forward transfer admittance	$ y_{fs} $	2.8	4.4	—	S	$I_D = 1.2 \text{ A}$ , $V_{DS} = 10 \text{ V}$ <sup>Note3</sup>
Input capacitance	$C_{iss}$	—	170	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	$C_{oss}$	—	24	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	$C_{rss}$	—	11	—	pF	$f = 1 \text{ MHz}$
Turn - on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = 1.2 \text{ A}$
Rise time	$t_r$	—	33	—	ns	$V_{GS} = 4.5 \text{ V}$
Turn - off delay time	$t_{d(off)}$	—	26	—	ns	$R_L = 8.3 \text{ } \Omega$
Fall time	$t_f$	—	5	—	ns	$R_g = 4.7 \text{ } \Omega$
Total gate charge	$Q_g$	—	2	—	nC	$V_{DD} = 10 \text{ V}$
Gate to Source charge	$Q_{gs}$	—	0.4	—	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	$Q_{gd}$	—	0.5	—	nC	$I_D = 2.4 \text{ A}$
Body - drain diode forward voltage	$V_{DF}$	—	0.8	—	V	$I_F = 2.4 \text{ A}$ , $V_{GS} = 0$ <sup>Note3</sup>

Notes: 3. Pulse test

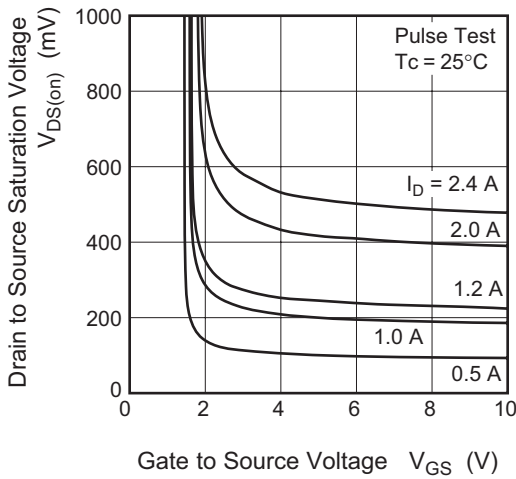
Main Characteristics



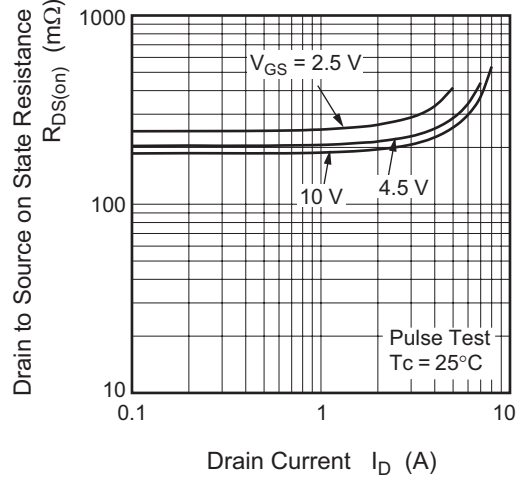
\*When using the glass epoxy board (FR-4 40 x 40 x 1 mm)



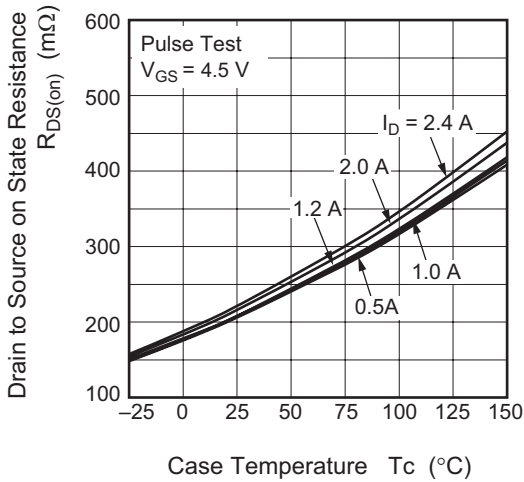
Drain to Source Saturation Voltage vs. Gate to Source Voltage



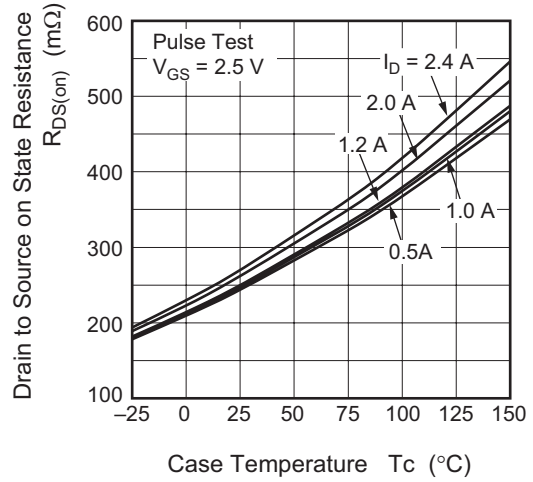
Static Drain to Source on State Resistance vs. Drain Current



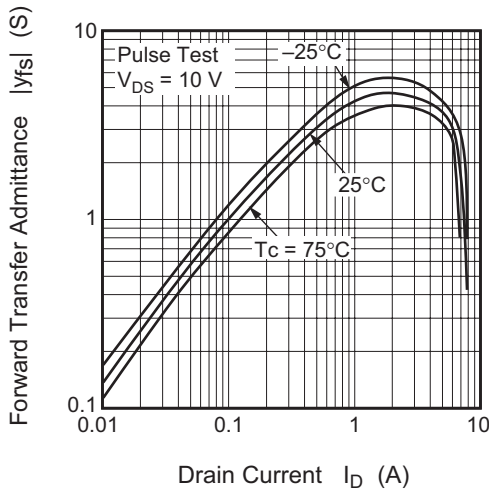
Static Drain to Source on State Resistance vs. Case Temperature (1)



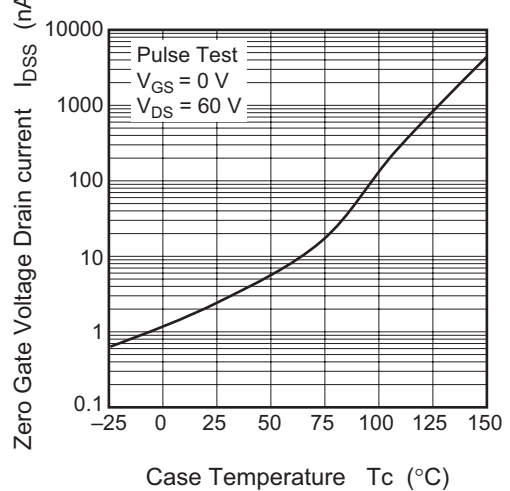
Static Drain to Source on State Resistance vs. Case Temperature (2)



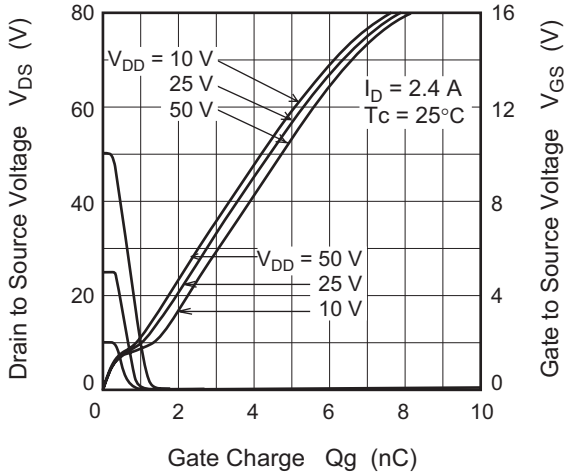
Forward Transfer Admittance vs. Drain Current



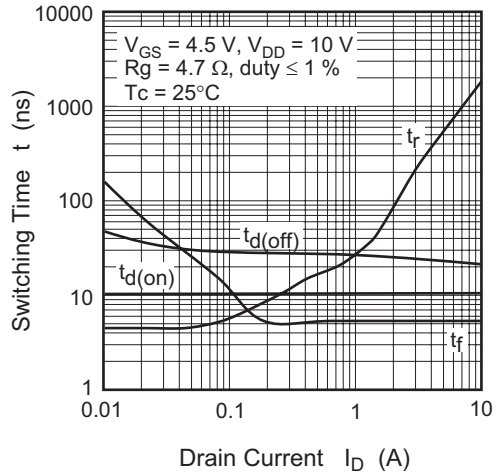
Zero Gate Voltage Drain current vs. Case Temperature



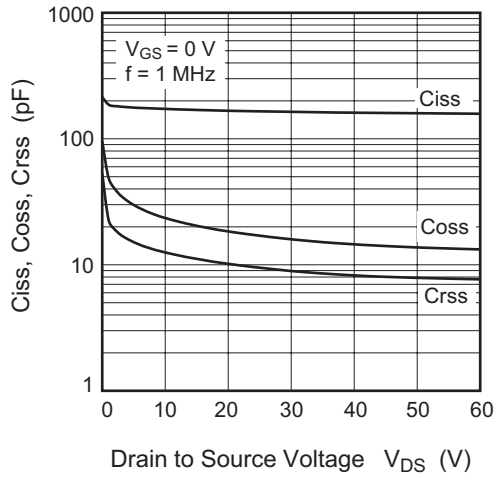
Dynamic Input Characteristics



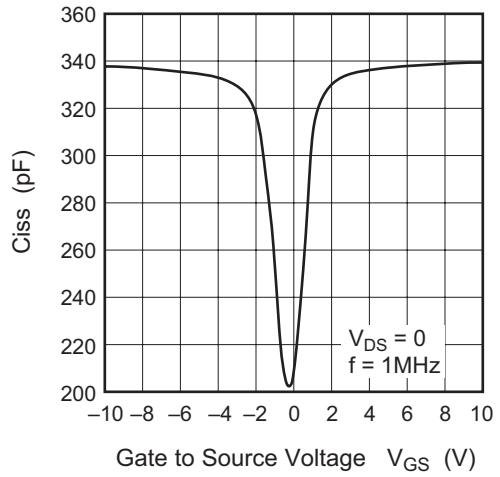
Switching Characteristics



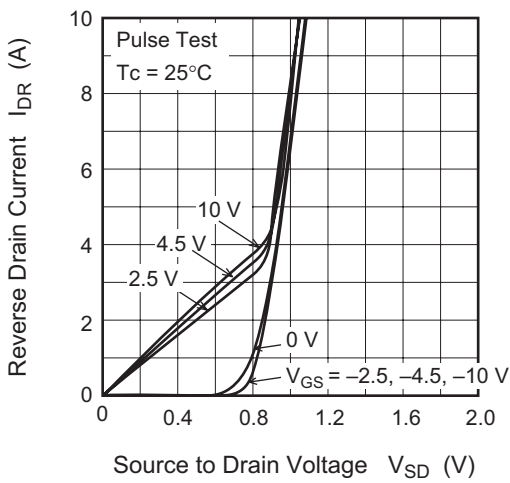
Typical Capacitance vs. Drain to Source Voltage



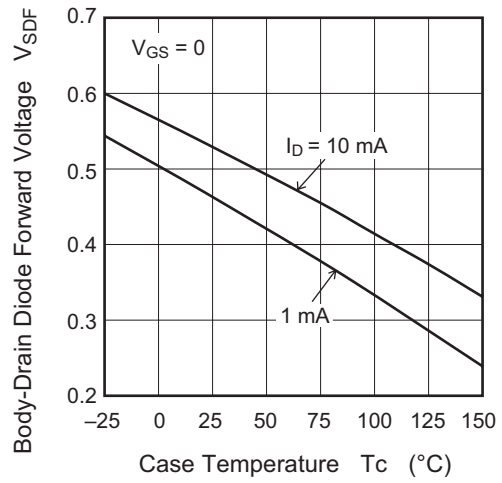
Input Capacitance vs. Gate to Source Voltage

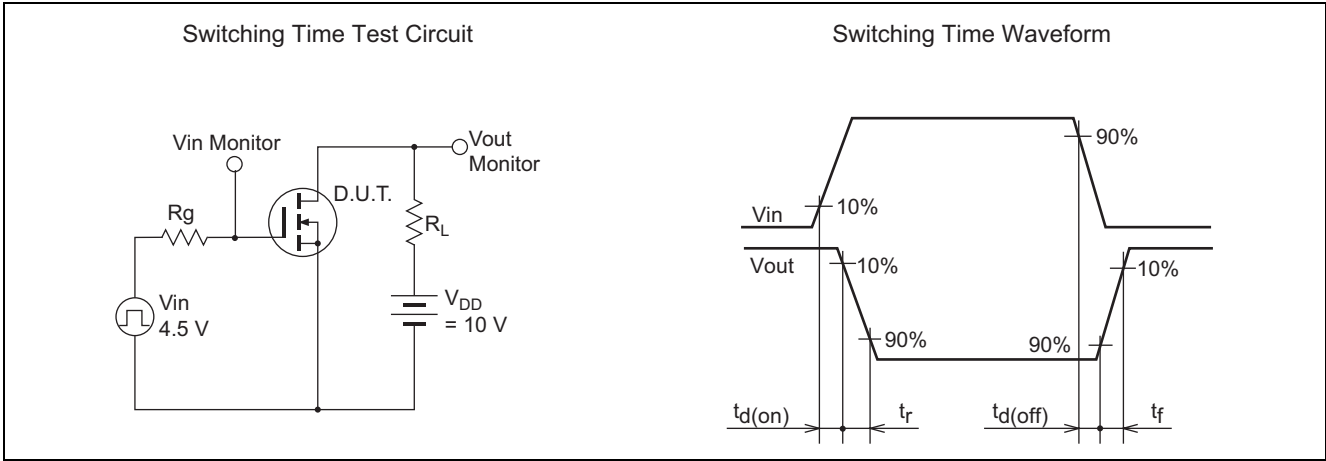


Reverse Drain Current vs. Source to Drain Voltage



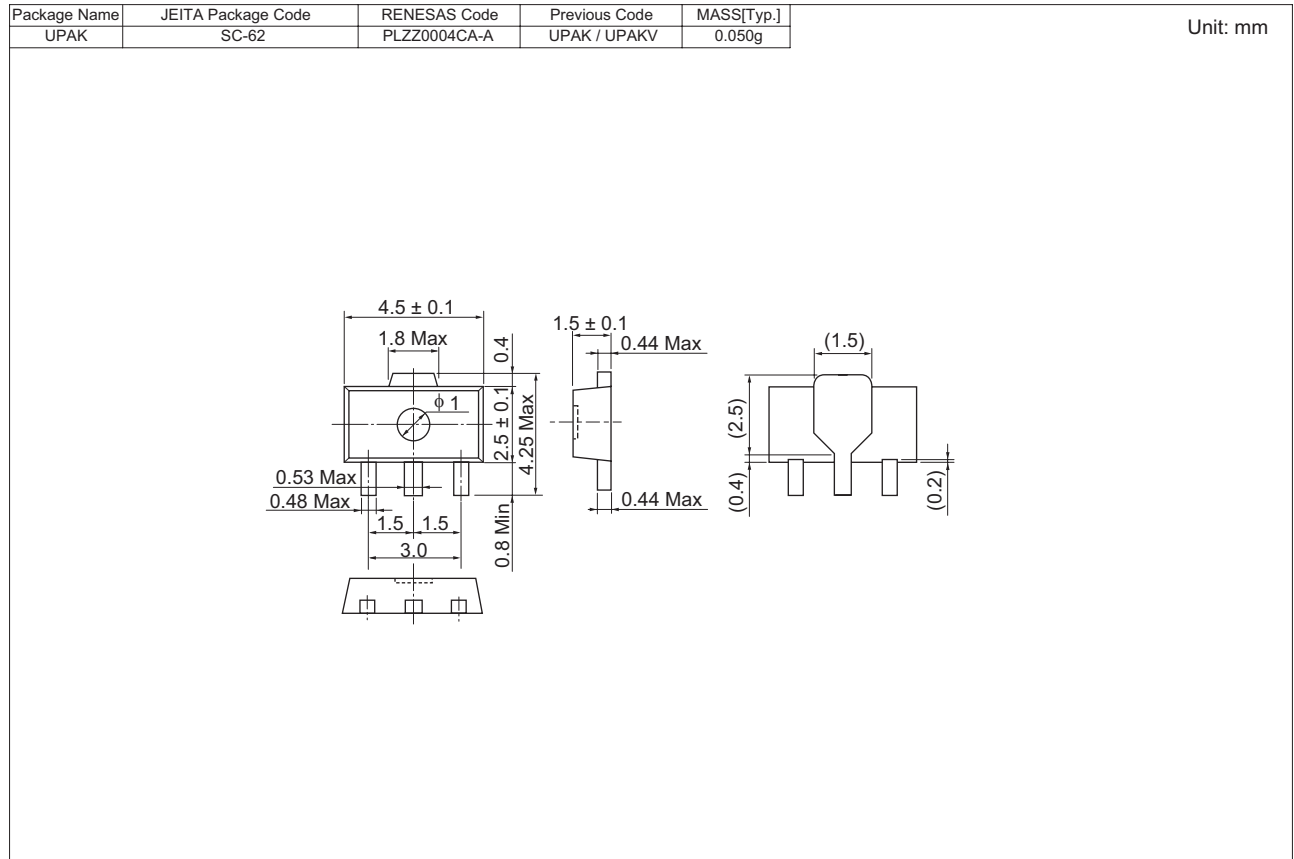
Body-Drain Diode Forward Voltage vs. Case Temperature







### Package Dimensions



### Ordering Information

Part No.	Quantity	Shipping Container
RQK0607AQDQSTL-E	1000 pcs.	$\phi 178$ mm reel, 12 mm Emboss taping

Notes:

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